

Wireless Connectivity Chipset Market Report: Trends, Forecast and Competitive Analysis to 2030

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Abstracts

Lucintel has been in the business of market research and management consulting since 2000 and has published over 1000 market intelligence reports in various markets / applications and served over 1,000 clients worldwide. This study is a culmination of four months of full-time effort performed by Lucintel's analyst team. The analysts used the following sources for the creation and completion of this valuable report:

In-depth interviews of the major players in this market

Detailed secondary research from competitors' financial statements and published data

Extensive searches of published works, market, and database information pertaining to industry news, company press releases, and customer intentions

A compilation of the experiences, judgments, and insights of Lucintel's professionals, who have analyzed and tracked this market over the years.

Extensive research and interviews are conducted across the supply chain of this market to estimate market share, market size, trends, drivers, challenges, and forecasts. Below is a brief summary of the primary interviews that were conducted by job function for this report.

Thus, Lucintel compiles vast amounts of data from numerous sources, validates the integrity of that data, and performs a comprehensive analysis. Lucintel then organizes the data, its findings, and insights into a concise report designed to support the strategic decision-making process. The figure below is a graphical representation of Lucintel's research process.

Contents

1. EXECUTIVE SUMMARY

2. GLOBAL WIRELESS CONNECTIVITY CHIPSET MARKET : MARKET DYNAMICS

2.1: Introduction, Background, and Classifications

2.2: Supply Chain

2.3: Industry Drivers and Challenges

3. MARKET TRENDS AND FORECAST ANALYSIS FROM 2018 TO 2030

3.1. Macroeconomic Trends (2018-2023) and Forecast (2024-2030)

3.2. Global Wireless Connectivity Chipset Market Trends (2018-2023) and Forecast (2024-2030)

3.3: Global Wireless Connectivity Chipset Market by Type

3.3.1: Wi-Fi Standalone

3.3.2: Bluetooth Standalone

3.3.3: Wi-Fi and Bluetooth Combo

3.3.4: Low-power Wireless IC

3.4: Global Wireless Connectivity Chipset Market by End Use

3.4.1: Consumer

3.4.2: Enterprise

3.4.3: Mobile Handsets

3.4.4: Automotive

3.4.5: Industrial

3.4.6: Others

4. MARKET TRENDS AND FORECAST ANALYSIS BY REGION FROM 2018 TO 2030

4.1: Global Wireless Connectivity Chipset Market by Region

4.2: North American Wireless Connectivity Chipset Market

4.2.2: North American Wireless Connectivity Chipset Market by End Use: Consumer, Enterprise, Mobile Handsets, Automotive, Industrial, and Others

4.3: European Wireless Connectivity Chipset Market

4.3.1: European Wireless Connectivity Chipset Market by Type: Wi-Fi Standalone, Bluetooth Standalone, Wi-Fi and Bluetooth Combo, and Low-power Wireless IC

4.3.2: European Wireless Connectivity Chipset Market by End Use: Consumer, Enterprise, Mobile Handsets, Automotive, Industrial, and Others

4.4: APAC Wireless Connectivity Chipset Market

4.4.1: APAC Wireless Connectivity Chipset Market by Type: Wi-Fi Standalone, Bluetooth Standalone, Wi-Fi and Bluetooth Combo, and Low-power Wireless IC

4.4.2: APAC Wireless Connectivity Chipset Market by End Use: Consumer, Enterprise, Mobile Handsets, Automotive, Industrial, and Others

4.5: ROW Wireless Connectivity Chipset Market

4.5.1: ROW Wireless Connectivity Chipset Market by Type: Wi-Fi Standalone, Bluetooth Standalone, Wi-Fi and Bluetooth Combo, and Low-power Wireless IC

4.5.2: ROW Wireless Connectivity Chipset Market by End Use: Consumer, Enterprise, Mobile Handsets, Automotive, Industrial, and Others

5. COMPETITOR ANALYSIS

5.1: Product Portfolio Analysis

5.2: Operational Integration

5.3: Porter's Five Forces Analysis

6. GROWTH OPPORTUNITIES AND STRATEGIC ANALYSIS

6.1: Growth Opportunity Analysis

6.1.1: Growth Opportunities for the Global Wireless Connectivity Chipset Market by Type

6.1.2: Growth Opportunities for the Global Wireless Connectivity Chipset Market by End Use

6.1.3: Growth Opportunities for the Global Wireless Connectivity Chipset Market by Region

6.2: Emerging Trends in the Global Wireless Connectivity Chipset Market

6.3: Strategic Analysis

6.3.1: New Product Development

6.3.2: Capacity Expansion of the Global Wireless Connectivity Chipset Market

6.3.3: Mergers, Acquisitions, and Joint Ventures in the Global Wireless Connectivity Chipset Market

6.3.4: Certification and Licensing

7. COMPANY PROFILES OF LEADING PLAYERS

7.1: Broadcom

- 7.2: Qualcomm Incorporated
- 7.3: Mediatek
- 7.4: Intel Corporation
- 7.5: Texas Instruments Incorporated
- 7.6: STMicroelectronics
- 7.7: NXP Semiconductors
- 7.8: On Semiconductor Corporation
- 7.9: Infineon Technologies
- 7.10: Microchip Technology

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